### 3.3 V/5 V ECL Dual Differential Data and Clock D Flip-Flop With Set and Reset

## MC10EP29, MC100EP29

## Description

The MC10/100EP29 is a dual master-slave flip-flop. The device features fully differential Data and Clock inputs as well as outputs. The MC10/100EP29 is functionally equivalent to the MC10/100EL29. Data enters the master latch when the clock is LOW and transfers to the slave upon a positive transition on the clock input.

The differential inputs have special circuitry which ensures device stability under open input conditions. When both differential inputs are left open the D input will pull down to $\mathrm{V}_{\mathrm{EE}}$ and the $\overline{\mathrm{D}}$ input will bias around $\mathrm{V}_{\mathrm{CC}} / 2$. The outputs will go to a defined state, however the state will be random based on how the flip flop powers up.

Both flip flops feature asynchronous, overriding Set and Reset inputs. Note that the Set and Reset inputs cannot both be HIGH simultaneously.

The $\mathrm{V}_{\mathrm{BB}}$ pin, an internally generated voltage supply, is available to this device only. For single-ended input conditions, the unused differential input is connected to $\mathrm{V}_{\mathrm{BB}}$ as a switching reference voltage. $\mathrm{V}_{\mathrm{BB}}$ may also rebias AC coupled inputs. When used, decouple $\mathrm{V}_{\mathrm{BB}}$ and $\mathrm{V}_{\mathrm{CC}}$ via a $0.01 \mu \mathrm{~F}$ capacitor and limit current sourcing or sinking to 0.5 mA . When not used, $\mathrm{V}_{\mathrm{BB}}$ should be left open.

The 100 Series contains temperature compensation.

## Features

- Maximum Frequency $>3 \mathrm{GHz}$ Typical
- 500 ps Typical Propagation Delays
- PECL Mode Operating Range: $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 5.5 V with $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$
- NECL Mode Operating Range: $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$
with $\mathrm{V}_{\mathrm{EE}}=-3.0 \mathrm{~V}$ to -5.5 V
- Open Input Default State
- Safety Clamp on Inputs
- These are $\mathrm{Pb}-$ Free Devices

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| XXXX | $=$ MC10 or 100 |
| :--- | :--- |
| A | $=$ Assembly Location |
| L | $=$ Wafer Lot |
| Y | $=$ Year |
| W | $=$ Work Week |
| - | $=$ Pb-Free Package |

(Note: Microdot may be in either location)
*For additional marking information, refer to
Application Note AND8002/D.
ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :---: | :---: | :---: |
| MC10EP29DTG | TSSOP-20 <br> (Pb-Free) | 75 Units / Tube |
| MC100EP29DTG | TSSOP-20 <br> (Pb-Free) | 75 Units / Tube |
| MC100EP29DTR2G | TSSOP-20 <br> (Pb-Free) |  <br> Reel |
| MC100EP29MNG | QFN-20 <br> (Pb-Free) | 92 Units / Tube |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.


Warning: All $\mathrm{V}_{\mathrm{CC}}$ and $\mathrm{V}_{\mathrm{EE}}$ pins must be externally connected to Power Supply to guarantee proper operation.
Figure 1. 20-Lead Pinout (Top View) and Logic Diagram
Exposed Pad


NOTE: The Exposed Pad (EP) on package bottom must be attached to a heat-sinking conduit. The Exposed Pad may only be electrically connected to $\mathrm{V}_{\mathrm{EE}}$.

Figure 1. QFN-20 Pinout (Top View)
Table 1. PIN DESCRIPTION

| Pin | Function |
| :---: | :---: |
| D0*, $\overline{\text { O }}^{*}$, D1*, $\overline{\mathrm{D} 1}^{*}$ | ECL Differential Data Inputs |
| R0*, R1* | ECL Reset Inputs |
| CLK0*, CLKO* | ECL Differential Clock Inputs |
| CLK1*, CLK1* | ECL Differential Clock Inputs |
| S0* S1* | ECL Set Inputs |
| Q0, $\overline{\text { Q0; }}$ Q1, $\overline{\text { Q1 }}$ | ECL Differential Data Outputs |
| $\mathrm{V}_{\mathrm{BB}}$ | Reference Voltage Output |
| $\mathrm{V}_{\mathrm{CC}}$ | Positive Supply |
| $\mathrm{V}_{\mathrm{EE}}$ | Negative Supply |
| EP | Exposed Pad |

Table 2. TRUTH TABLE

| $\mathbf{R}$ | $\mathbf{S}$ | $\mathbf{D}$ | CLK | $\mathbf{Q}$ | $\overline{\mathbf{Q}}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| L | L | L | Z | L | H |
| L | L | H | Z | H | L |
| H | L | X | X | L | H |
| L | H | X | X | H | L |
| H | H | X | X | Undef | Undef |

$Z=L O W$ to HIGH Transition
$X=$ Don't Care
*Pins will default LOW when left open.

## MC10EP29, MC100EP29

Table 3. ATTRIBUTES

| Characteristics | Value |
| :---: | :---: |
| Internal Input Pulldown Resistor | $75 \mathrm{k} \Omega$ |
| Internal Input Pullup Resistor | N/A |
| ESD Protection Human Body Model Machine Model Charged Device Model | $\begin{gathered} >2 \mathrm{kV} \\ >100 \mathrm{~V} \\ >2 \mathrm{kV} \end{gathered}$ |
| Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1) | Pb-Free Pkg |
| $\begin{aligned} & \text { TSSOP-20 } \\ & \text { QFN-20 } \end{aligned}$ | Level 3 Level 1 |
| Flammability Rating Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in |
| Transistor Count | 383 Devices |
| Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test |  |

1. For additional information, see Application Note AND8003/D.

Table 4. MAXIMUM RATINGS

| Symbol | Parameter | Condition 1 | Condition 2 | Rating | Unit |
| :---: | :--- | :--- | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | PECL Mode Power Supply | $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ |  | 6 | V |
| $\mathrm{~V}_{\mathrm{EE}}$ | NECL Mode Power Supply | $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$ |  | -6 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | PECL Mode Input Voltage <br> NECL Mode Input Voltage | $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ <br> $\mathrm{~V}_{\mathrm{CC}}=0 \mathrm{~V}$ | $\mathrm{V}_{\mathrm{I}} \leq \mathrm{V}_{\mathrm{CC}}$ <br> $\mathrm{V}_{\mathrm{I}} \geq \mathrm{V}_{\mathrm{EE}}$ | Continuous <br> Surge |  |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 5. 10EP DC CHARACTERISTICS, PECL $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 2)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 3) | 2165 | 2290 | 2415 | 2230 | 2355 | 2480 | 2290 | 2415 | 2540 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 3) | 1365 | 1490 | 1615 | 1430 | 1555 | 1680 | 1490 | 1615 | 1740 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | 2090 |  | 2415 | 2155 |  | 2480 | 2215 |  | 2540 | mV |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Single-Ended) | 1365 |  | 1690 | 1460 |  | 1755 | 1490 |  | 1815 | mV |
| $\mathrm{V}_{\text {BB }}$ | Output Voltage Reference | 1790 | 1890 | 1990 | 1855 | 1955 | 2055 | 1915 | 2015 | 2115 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4) | 2.0 |  | 3.3 | 2.0 |  | 3.3 | 2.0 |  | 3.3 | V |
| IIH | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| IIL | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
2. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. $\mathrm{V}_{\mathrm{EE}}$ can vary +0.3 V to -2.2 V .
3. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
4. $V_{I H C M R}$ min varies $1: 1$ with $V_{E E}, V_{I H C M R}$ max varies $1: 1$ with $V_{C C}$. The $V_{I H C M R}$ range is referenced to the most positive side of the differential input signal.

Table 6. 10EP DC CHARACTERISTICS, PECL $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 5)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $I_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 6) | 3865 | 3990 | 4115 | 3930 | 4055 | 4180 | 3990 | 4115 | 4240 | mV |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage (Note 6) | 3065 | 3190 | 3315 | 3130 | 3255 | 3380 | 3190 | 3315 | 3440 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | 3790 |  | 4115 | 3855 |  | 4180 | 3915 |  | 4240 | mV |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Single-Ended) | 3065 |  | 3390 | 3130 |  | 3455 | 3190 |  | 3515 | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Voltage Reference | 3490 | 3590 | 3690 | 3555 | 3655 | 3755 | 3615 | 3715 | 3815 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 7) | 2.0 |  | 5.0 | 2.0 |  | 5.0 | 2.0 |  | 5.0 | V |
| $\mathrm{I}_{\mathrm{H}}$ | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.
5. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. $\mathrm{V}_{\mathrm{EE}}$ can vary +2.0 V to -0.5 V .
6. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
7. $V_{I H C M R}$ min varies $1: 1$ with $\mathrm{V}_{\mathrm{EE}}, \mathrm{V}_{\mathrm{IHCMR}}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\mathrm{IHCMR}}$ range is referenced to the most positive side of the differential input signal.

Table 7. 10EP DC CHARACTERISTICS, NECL $V_{C C}=0 \mathrm{~V} ; \mathrm{V}_{\mathrm{EE}}=-5.5 \mathrm{~V}$ to -3.0 V (Note 8)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| VOH | Output HIGH Voltage (Note 9) | -1135 | -1010 | -885 | -1070 | -945 | -820 | -1010 | -885 | -760 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 9) | -1935 | -1810 | -1685 | -1870 | -1745 | -1620 | -1810 | -1685 | -1560 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | -1210 |  | -885 | -1145 |  | -820 | -1085 |  | -760 | mV |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Single-Ended) | -1935 |  | -1610 | -1870 |  | -1545 | -1810 |  | -1485 | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Voltage Reference | -1510 | -1410 | -1310 | -1445 | -1345 | -1245 | -1385 | -1285 | -1185 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 10) | $\mathrm{V}_{\mathrm{EE}}+2.0$ |  | 0.0 | $\mathrm{V}_{\mathrm{EE}}+2.0$ |  | 0.0 | $\mathrm{V}_{\mathrm{EE}}+2.0$ |  | 0.0 | V |
| IIH | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| ILL | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.
8. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$.
9. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{Cc}}-2.0 \mathrm{~V}$.
10. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{E E}, \mathrm{~V}_{I H C M R}$ max varies $1: 1$ with $\mathrm{V}_{C C}$. The $\mathrm{V}_{I H C M R}$ range is referenced to the most positive side of the differential input signal.

Table 8. 100EP DC CHARACTERISTICS, PECL $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V}, \mathrm{~V}_{\text {EE }}=0 \mathrm{~V}$ (Note 11)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 12) | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | 2155 | 2280 | 2405 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 12) | 1305 | 1480 | 1605 | 1305 | 1480 | 1605 | 1305 | 1480 | 1605 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | 2075 |  | 2420 | 2075 |  | 2420 | 2075 |  | 2420 | mV |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Single-Ended) | 1305 |  | 1675 | 1305 |  | 1675 | 1305 |  | 1675 | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Voltage Reference | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | 1775 | 1875 | 1975 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 13) | 2.0 |  | 3.3 | 2.0 |  | 3.3 | 2.0 |  | 3.3 | V |
| IIH | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| ILL | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
11. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}} . \mathrm{V}_{\mathrm{EE}}$ can vary +0.3 V to -2.2 V .
12. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
13. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{\text {EE }}, \mathrm{V}_{\text {IHCMR }}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\text {IHCMR }}$ range is referenced to the most positive side of the differential input signal.

Table 9. 100EP DC CHARACTERISTICS, PECL $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 14)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{I}_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 15) | 3855 | 3980 | 4105 | 3855 | 3980 | 4105 | 3855 | 3980 | 4105 | mV |
| $\mathrm{V}_{\text {OL }}$ | Output LOW Voltage (Note 15) | 3005 | 3180 | 3305 | 3005 | 3180 | 3305 | 3005 | 3180 | 3305 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | 3775 |  | 4120 | 3775 |  | 4120 | 3775 |  | 4120 | mV |
| $\mathrm{V}_{\mathrm{IL}}$ | Input LOW Voltage (Single-Ended) | 3005 |  | 3375 | 3005 |  | 3375 | 3005 |  | 3375 | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Voltage Reference | 3475 | 3575 | 3675 | 3475 | 3575 | 3675 | 3475 | 3575 | 3675 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 16) | 2.0 |  | 5.0 | 2.0 |  | 5.0 | 2.0 |  | 5.0 | V |
| $\mathrm{IIH}^{\text {H }}$ | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| ILL | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
14. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. $\mathrm{V}_{\mathrm{EE}}$ can vary +2.0 V to -0.5 V .
15. All loading with $50 \Omega$ to $\mathrm{V}_{C C}-2.0 \mathrm{~V}$.
16. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{\mathrm{EE}}, \mathrm{V}_{\text {IHCMR }}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\text {IHCMR }}$ range is referenced to the most positive side of the differential input signal.

Table 10. 100EP DC CHARACTERISTICS, NECL $V_{C C}=0 \mathrm{~V} ; \mathrm{V}_{\mathrm{EE}}=-5.5 \mathrm{~V}$ to -3.0 V (Note 17)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $I_{\text {EE }}$ | Power Supply Current | 35 | 46 | 55 | 37 | 48 | 57 | 40 | 49 | 60 | mA |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage (Note 18) | -1145 | -1020 | -895 | -1145 | -1020 | -895 | -1145 | -1020 | -895 | mV |
| $\mathrm{V}_{\mathrm{OL}}$ | Output LOW Voltage (Note 18) | -1995 | -1820 | -1695 | -1995 | -1820 | -1695 | -1995 | -1820 | -1695 | mV |
| $\mathrm{V}_{\mathrm{IH}}$ | Input HIGH Voltage (Single-Ended) | -1225 |  | -880 | -1225 |  | -880 | -1225 |  | -880 | mV |
| $\mathrm{V}_{\text {IL }}$ | Input LOW Voltage (Single-Ended) | -1995 |  | -1625 | -1995 |  | -1625 | -1995 |  | -1625 | mV |
| $\mathrm{V}_{\mathrm{BB}}$ | Output Voltage Reference | -1525 | -1425 | -1325 | -1525 | -1425 | -1325 | -1525 | -1425 | -1325 | mV |
| $\mathrm{V}_{\text {IHCMR }}$ | Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 19) | $\mathrm{V}_{\mathrm{EE}}$ | 2.0 | 0.0 | $\mathrm{V}_{\mathrm{EE}}$ | 2.0 | 0.0 | $\mathrm{V}_{\mathrm{EE}}$ | 2.0 | 0.0 | V |
| IIH | Input HIGH Current |  |  | 150 |  |  | 150 |  |  | 150 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {IL }}$ | Input LOW Current | 0.5 |  |  | 0.5 |  |  | 0.5 |  |  | $\mu \mathrm{A}$ |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.
17. Input and output parameters vary $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$.
18. All loading with $50 \Omega$ to $V_{C C}-2.0 \mathrm{~V}$.
19. $\mathrm{V}_{\text {IHCMR }}$ min varies $1: 1$ with $\mathrm{V}_{\mathrm{EE}}, \mathrm{V}_{\text {IHCMR }}$ max varies $1: 1$ with $\mathrm{V}_{\mathrm{CC}}$. The $\mathrm{V}_{\text {IHCMR }}$ range is referenced to the most positive side of the differential input signal.

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Table 11. AC CHARACTERISTICS $\mathrm{V}_{\mathrm{CC}}=0 \mathrm{~V}$; $\mathrm{V}_{\mathrm{EE}}=-3.0 \mathrm{~V}$ to -5.5 V or $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ to 5.5 V ; $\mathrm{V}_{\mathrm{EE}}=0 \mathrm{~V}$ (Note 20)

| Symbol | Characteristic | $-40^{\circ} \mathrm{C}$ |  |  | $25^{\circ} \mathrm{C}$ |  |  | $85^{\circ} \mathrm{C}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max | Min | Typ | Max | Min | Typ | Max |  |
| $\mathrm{f}_{\text {max }}$ | Maximum Frequency (See Figure $2 \mathrm{~F}_{\text {max }} /$ JITTER) |  | > 3.0 |  |  | > 3.0 |  |  | > 3.0 |  | GHz |
| $\begin{aligned} & \mathrm{t}_{\mathrm{PLH}}, \\ & \mathrm{t}_{\text {PHL }} \end{aligned}$ | Propagation Delay to Output Differential S R $\quad$ CLK | $\begin{aligned} & 300 \\ & 275 \\ & 300 \end{aligned}$ | $\begin{aligned} & 380 \\ & 380 \\ & 400 \end{aligned}$ | $\begin{aligned} & \hline 450 \\ & 475 \\ & 500 \end{aligned}$ | $\begin{aligned} & 350 \\ & 300 \\ & 325 \end{aligned}$ | $\begin{aligned} & \hline 420 \\ & 400 \\ & 420 \end{aligned}$ | $\begin{aligned} & \hline 500 \\ & 500 \\ & 525 \end{aligned}$ | $\begin{aligned} & 400 \\ & 350 \\ & 375 \end{aligned}$ | $\begin{aligned} & \hline 470 \\ & 450 \\ & 470 \end{aligned}$ | $\begin{aligned} & 550 \\ & 550 \\ & 575 \end{aligned}$ | ps |
| $\begin{aligned} & \mathrm{t}_{\mathrm{S}} \\ & \mathrm{t}_{\mathrm{H}} \end{aligned}$ | Setup Time Hold Time | $\begin{aligned} & \hline 100 \\ & 100 \end{aligned}$ | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  | $\begin{aligned} & \hline 100 \\ & 100 \end{aligned}$ | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  | $\begin{aligned} & \hline 100 \\ & 100 \end{aligned}$ | $\begin{aligned} & 20 \\ & 20 \end{aligned}$ |  | ps |
| $\mathrm{t}_{\mathrm{RR}} / \mathrm{t}_{\mathrm{RR} 2}$ | Set/Reset Recovery | 150 | 80 |  | 150 | 80 |  | 150 | 80 |  | ps |
| $t_{\text {PW }}$ | Minimum Pulse Width Set, Reset | 500 | 300 |  | 500 | 300 |  | 500 | 300 |  | ps |
| $\mathrm{t}_{\text {IITTER }}$ | Cycle-to-Cycle Jitter (See Figure $2 \mathrm{~F}_{\text {max }} / \mathrm{JITTER}$ ) |  | 0.2 | <1 |  | 0.2 | <1 |  | 0.2 | < 1 | ps |
| $\mathrm{V}_{\mathrm{PP}}$ | Input Voltage Swing (Note 21) | 150 | 800 | 1200 | 150 | 800 | 1200 | 150 | 800 | 1200 | mV |
| $\mathrm{t}_{\mathrm{r}}$ $\mathrm{t}_{\mathrm{f}}$ | Output Rise/Fall Times $(20 \%-80 \%)$$\quad$ Q, $\bar{Q}$ | 100 | 180 | 250 | 150 | 210 | 300 | 175 | 230 | 325 | ps |

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 Ifpm.
20. Measured using a 750 mV source, $50 \%$ duty cycle clock source. All loading with $50 \Omega$ to $\mathrm{V}_{\mathrm{CC}}-2.0 \mathrm{~V}$.
21. $\mathrm{V}_{\mathrm{PP}}(\mathrm{min})$ is the minimum input swing for which AC parameters are guaranteed.

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.


Figure 2. $\mathrm{F}_{\text {max }} /$ Jitter


Figure 3. Typical Termination for Output Driver and Device Evaluation (See Application Note AND8020/D - Termination of ECL Logic Devices.)

Resource Reference of Application Notes
AN1405/D - ECL Clock Distribution Techniques
AN1406/D - Designing with PECL (ECL at +5.0 V )
AN1503/D - ECLinPS $^{m}$ I/O SPiCE Modeling Kit
AN1504/D - Metastability and the ECLinPS Family $_{\text {AN1568/D }}$ - Interfacing Between LVDS and ECL
AN1672/D - The ECL Translator Guide
AND8001/D - Odd Number Counters Design
AND8002/D - Marking and Date Codes
AND8020/D - Termination of ECL Logic Devices
AND8066/D - Interfacing with ECLinPS
AND8090/D - AC Characteristics of ECL Devices

# QFN20, 4x4, 0.5P 

CASE 485E
ISSUE C
DATE 13 FEB 2018

## SCALE 2:1



1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM THE TERMINAL TIP
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 0.80 | 1.00 |
| A1 | --- | 0.05 |
| A3 | 0.20 |  |
| REF |  |  |
| b | 0.20 |  |
| D | 4.00 |  |
| DSC | 0.30 |  |
| E | 2.60 |  |
| 4.00 |  | BSC |
| E2 | 2.60 |  |
| e | 0.50 |  |

GENERIC MARKING DIAGRAM*


XXXXXX= Specific Device Code
A = Assembly Location
LL = Wafer Lot
Y = Year
W = Work Week

- = Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " $\quad$ ", may or may not be present. Some products may not follow the Generic Marking.


DIMENSIONS: MILLIMETERS
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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TSSOP-20 WB
CASE 948E
ISSUE D
DATE 17 FEB 2016

SCALE 2:1


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982
CONTROLLING DIMENSION: MILLIMETER
2. DIMENSION A DOES NOT INCLUDE MOLD

FLASH, PROTRUSIONS OR GATE BURRS.
FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH OR GATE BURRS SHALL NO
EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE

INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION. SHALL NOT EXCEED $0.25(0.010)$ PER SIDE
5. DIMENSION K DOES NOT INCLUDE

DAMBAR PROTRUSION. ALLOWABLE
DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-

|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |
| A | 6.40 | 6.60 | 0.252 | 0.260 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC |  | 0.026 BSC |  |
| H | 0.27 | 0.37 | 0.011 | 0.015 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 | BSC | 0.252 BSC |  |
| M | 0 | $0^{\circ}$ | $8^{\circ}$ | 0 |

GENERIC MARKING DIAGRAM* НРННННННН

|  | XXXX |
| :---: | :---: |
|  | XXXX |
|  | ALYW. |
| $\bigcirc$ | - |

A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

- = Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, " G " or microdot " $\mathrm{\nabla}$ ", may or may not be present.
DIMENSIONS: MILLIMETERS

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